

Features

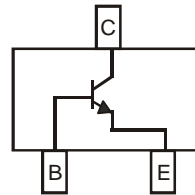
- Epitaxial Planar Die Construction
- Ideal for Medium Power Amplification and Switching
- High Collector Current Rating
- Complementary Version Available (DPBT8105)
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **"Green Device" (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish — Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)



Top View



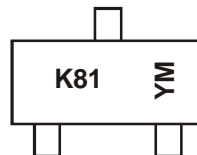
Device Schematic

Ordering Information (Note 3)

| Part Number | Case | Packaging |
|-------------|--------|------------------|
| DNBT8105-7 | SOT-23 | 3000/Tape & Reel |

- Notes:
1. No purposefully added lead.
 2. Diode's Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 3. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



K81 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: S = 2005)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | R | S | T | U | V | W | X | Y | Z | A | B | C |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--------------------------------|-----------|-------|------|
| Collector-Base Voltage | V_{CBO} | 80 | V |
| Collector-Emitter Voltage | V_{CEO} | 60 | V |
| Emitter-Base Voltage | V_{EBO} | 5 | V |
| Collector Current - Continuous | I_C | 1 | A |
| Peak Pulse Collector Current | I_{CM} | 2 | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|---------------------------|
| Power Dissipation (Note 4) @ $T_A = 25^\circ\text{C}$ | P_D | 600 | mW |
| Thermal Resistance, Junction to Ambient (Note 4) @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$ | 209 | $^\circ\text{C}/\text{W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -55 to +150 | $^\circ\text{C}$ |

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|--------------------------------------|---------------|-----|-------------|------|--|
| OFF CHARACTERISTICS (Note 5) | | | | | |
| Collector-Base Breakdown Voltage | $V_{(BR)CBO}$ | 80 | — | V | $I_C = 100\mu\text{A}, I_E = 0$ |
| Collector-Emitter Breakdown Voltage | $V_{(BR)CEO}$ | 60 | — | V | $I_C = 10\text{mA}, I_B = 0$ |
| Emitter-Base Breakdown Voltage | $V_{(BR)EBO}$ | 5 | — | V | $I_E = 100\mu\text{A}, I_C = 0$ |
| Collector Cutoff Current | I_{CBO} | — | 100 | nA | $V_{CB} = 60\text{V}, I_E = 0$ |
| Collector Cutoff Current | I_{CES} | — | 100 | nA | $V_{CE} = 60\text{V}$ |
| Emitter Cutoff Current | I_{EBO} | — | 100 | nA | $V_{EB} = 4\text{V}, I_C = 0$ |
| ON CHARACTERISTICS (Note 5) | | | | | |
| DC Current Gain | h_{FE} | 100 | — | — | $I_C = 1\text{mA}, V_{CE} = 5\text{V}$ $I_C = 500\text{mA}, V_{CE} = 5\text{V}$ $I_C = 1\text{A}, V_{CE} = 5\text{V}$ $I_C = 2\text{A}, V_{CE} = 5\text{V}$ |
| | | 100 | 300 | | |
| | | 80 | — | | |
| | | 30 | — | | |
| Collector-Emitter Saturation Voltage | $V_{CE(SAT)}$ | — | 0.25 0.5 | V | $I_C = 500\text{mA}, I_B = 50\text{mA}$ $I_C = 1\text{A}, I_B = 100\text{mA}$ |
| Base-Emitter Saturation Voltage | $V_{BE(SAT)}$ | — | 1.1 | V | $I_C = 1\text{A}, I_B = 100\text{mA}$ |
| Base-Emitter Turn On Voltage | $V_{BE(ON)}$ | — | 1.0 | V | $I_C = 1\text{A}, V_{CE} = 5\text{V}$ |
| SMALL SIGNAL CHARACTERISTICS | | | | | |
| Output Capacitance | C_{obo} | — | 10 | pF | $V_{CB} = 10\text{V}, f = 1.0\text{MHz}$ |
| Current Gain-Bandwidth Product | f_T | 150 | — | MHz | $V_{CE} = 10\text{V}, I_C = 50\text{mA}, f = 100\text{MHz}$ |

- Notes:
- Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Short duration pulse test used to minimize self-heating effect.

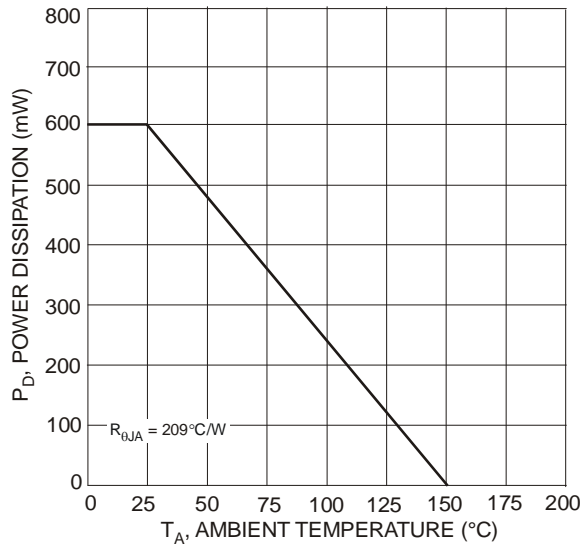


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 1)

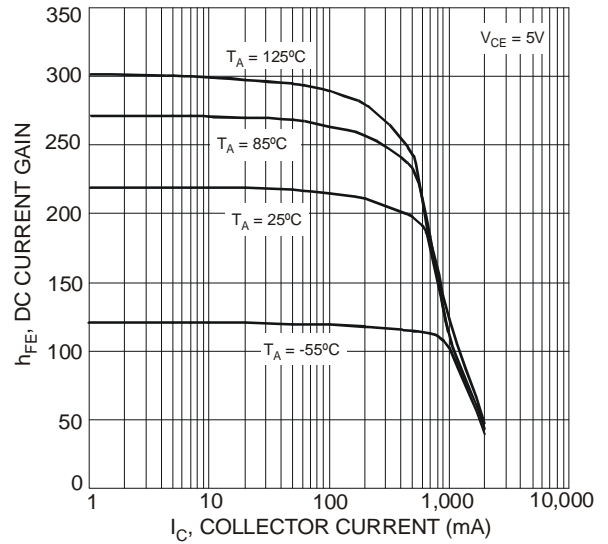


Fig. 2 DC Current Gain vs. Collector Current

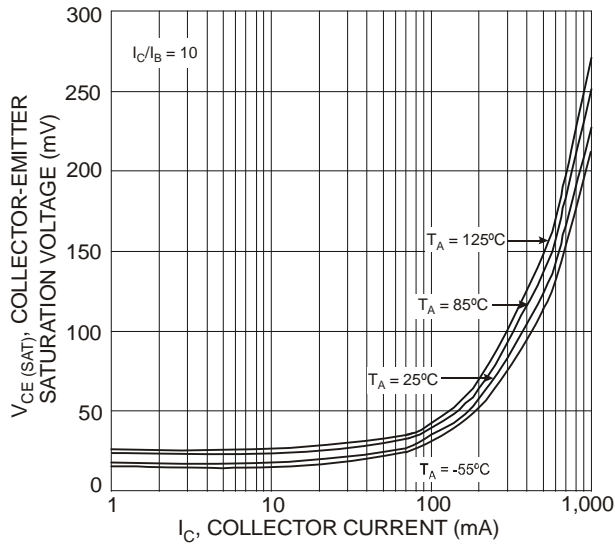


Fig. 3 Typical Collector-Emitter Saturation Voltage vs. Collector Current

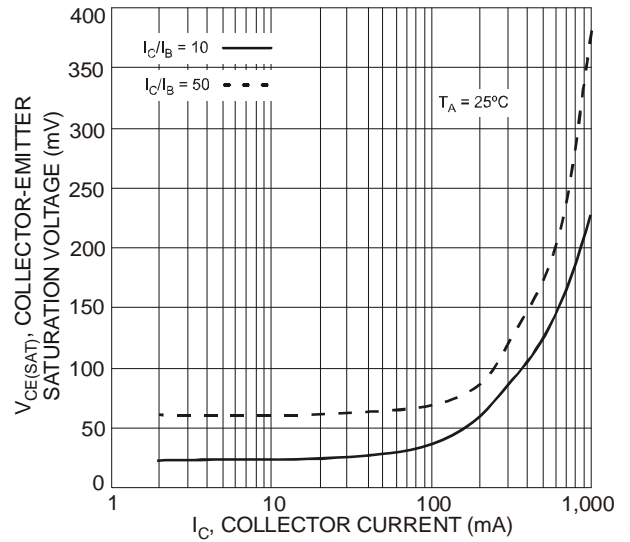


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

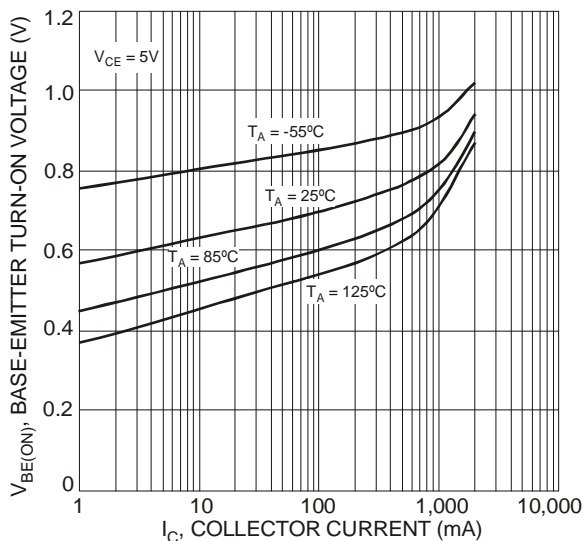


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current

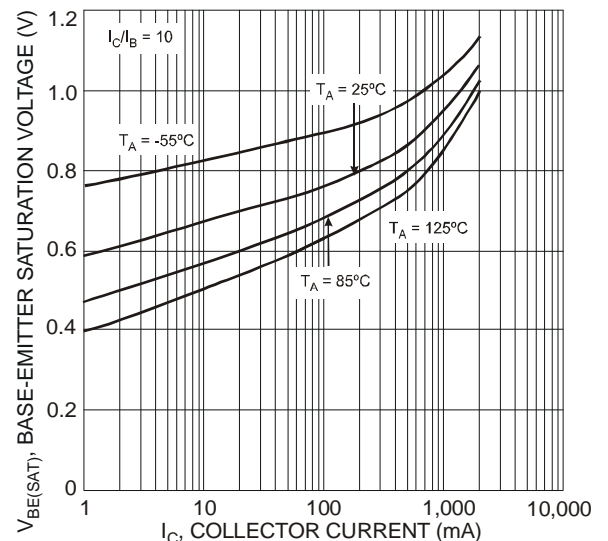


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

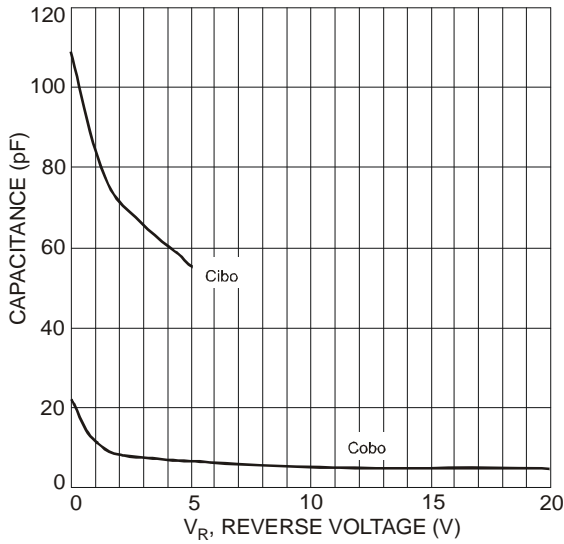
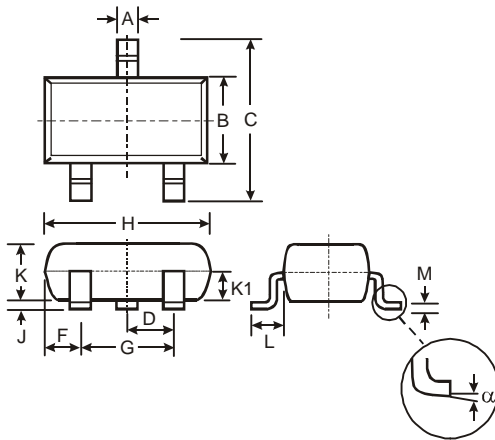


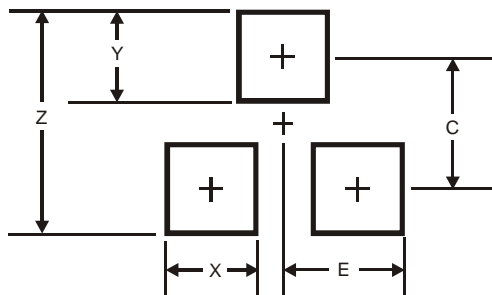
Fig. 7 Typical Capacitance Characteristics

Package Outline Dimensions



| SOT-23 | | | |
|----------------------|-------|------|-------|
| Dim | Min | Max | Typ |
| A | 0.37 | 0.51 | 0.40 |
| B | 1.20 | 1.40 | 1.30 |
| C | 2.30 | 2.50 | 2.40 |
| D | 0.89 | 1.03 | 0.915 |
| F | 0.45 | 0.60 | 0.535 |
| G | 1.78 | 2.05 | 1.83 |
| H | 2.80 | 3.00 | 2.90 |
| J | 0.013 | 0.10 | 0.05 |
| K | 0.903 | 1.10 | 1.00 |
| K1 | - | - | 0.400 |
| L | 0.45 | 0.61 | 0.55 |
| M | 0.085 | 0.18 | 0.11 |
| α | 0° | 8° | - |
| All Dimensions in mm | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.9 |
| X | 0.8 |
| Y | 0.9 |
| C | 2.0 |
| E | 1.35 |

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